

# TLP109

Programmable Controllers  
 Industrial Inverters  
 Switching Power Supplies

The Toshiba TLP109 mini-flat coupler is a small-outline coupler suitable for surface-mount assembly.

The TLP109 consists of a high-output-power GaAlAs light emitting diode optically coupled to a high-speed photodiode-transistor chip.

The TLP109 is housed in the SO6 package and guarantees a creepage distance of  $\geq 5.0$  mm, a clearance of  $\geq 5.0$  mm and an insulation thickness of  $\geq 0.4$  mm. Therefore, the TLP109 meets the reinforced insulation class requirements of international safety standards.

- Isolation voltage: 3750 Vrms (min)
- Switching speed:  $t_{pHL} = 0.8 \mu s$ ,  $t_{pLH} = 0.8 \mu s$  (max)  
 @ $R_L = 1.9 k\Omega$
- TTL-compatible
- UL approved :UL1577, File No.E67349
- c-UL approved :CSA Component Acceptance Service No. 5A, File No.E67349
- Option (V4)  
 VDE approved : DIN EN60747-5-2

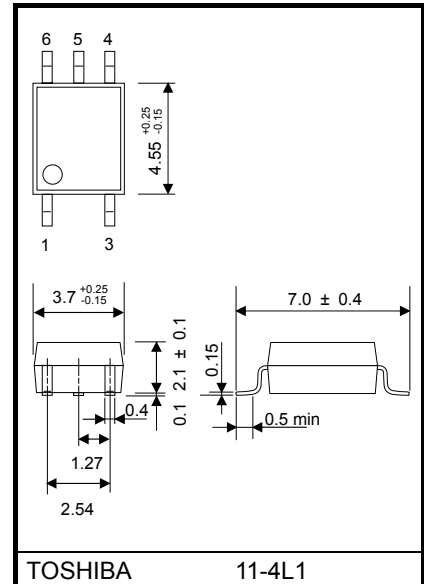
Maximum Operating Insulation Voltage : 707 V<sub>PK</sub>

Highest Permissible Over Voltage : 6000 V<sub>PK</sub>

(Note) : When a EN60747-5-2 approved type is needed,

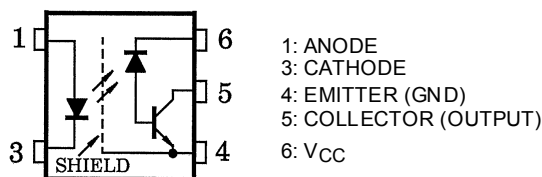
Please designate "Option(V4)"

Unit: mm

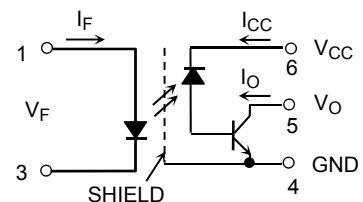


Weight: 0.08 g (typ.)

## Pin Configuration (Top View)



## Schematic



## Construction Mechanical Ratings

- Creepage distance: 5.0 mm (min)
- Clearance: 5.0 mm (min)
- Insulation thickness: 0.4 mm (min)

Start of commercial production  
 2008/07

## Absolute Maximum Ratings (Ta = 25°C)

Characteristic		Symbol	Rating	Unit
LED	Forward current (Note 1)	$I_F$	20	mA
	Pulse forward current (Note 2)	$I_{FP}$	40	mA
	Peak transient forward current (Note 3)	$I_{FPT}$	1	A
	Reverse voltage	$V_R$	5	V
	Power dissipation (Note 4)	$P_D$	40	mW
Detector	Output current	$I_O$	8	mA
	Peak output current	$I_{OP}$	16	mA
	Supply voltage	$V_{CC}$	-0.5 to 30	V
	Output voltage	$V_O$	-0.5 to 20	V
	Output power dissipation (Note 5)	$P_O$	100	mW
Operating temperature range		$T_{opr}$	-55 to 125	°C
Storage temperature range		$T_{stg}$	-55 to 125	°C
Lead solder temperature (10 s)		$T_{sol}$	260	°C
Isolation Voltage (AC, 1 minute, R.H. ≤ 60%) (Note 6)		$BV_S$	3750	Vrms

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

(Note 1) Derate 0.36 mA / °C above 95°C.

(Note 2) 50% duty cycle, 1 ms pulse width. Derate 0.72 mA / °C above 95°C.

(Note 3) Pulse width ≤ 1 μs, 300 pps.

(Note 4) Derate 0.72 mA / °C above 95°C.

(Note 5) Derate 1.8 mW / °C above 95°C.

(Note 6) Device considered a two-terminal device: Pins 1 and 3 shorted together, and pins 4, 5 and 6 shorted together.

## Electrical Characteristics (Ta = 25°C)

Characteristic		Symbol	Test Condition	Min	Typ.	Max	Unit
LED	Forward voltage	$V_F$	$I_F = 16 \text{ mA}$	1.50	1.64	1.85	V
	Forward voltage temperature coefficient	$\Delta V_F / \Delta T_a$	$I_F = 16 \text{ mA}$	—	-1.6	—	mV/°C
	Reverse current	$I_R$	$V_R = 3 \text{ V}$	—	—	10	$\mu\text{A}$
	Capacitance between terminals	$C_T$	$V_F = 0 \text{ V}, f = 1 \text{ MHz}$	—	60	—	pF
Detector	High level output current	$I_{OH(1)}$	$I_F = 0 \text{ mA}, V_{CC} = V_O = 5.5 \text{ V}$	—	3	500	nA
		$I_{OH(2)}$	$I_F = 0 \text{ mA}, V_{CC} = 30 \text{ V}, V_O = 20 \text{ V}$	—	—	5	$\mu\text{A}$
		$I_{OH}$	$I_F = 0 \text{ mA}, V_{CC} = 30 \text{ V}, V_O = 20 \text{ V}, T_a = 100^\circ\text{C}$	—	—	50	
	High level supply current	$I_{CCH}$	$I_F = 0 \text{ mA}, V_{CC} = 30 \text{ V}$	—	0.01	1	$\mu\text{A}$
Current transfer ratio	$I_O / I_F$	$I_F = 16 \text{ mA}, V_{CC} = 4.5 \text{ V}, V_O = 0.4 \text{ V}$	20	—	—	%	
Low level output voltage	$V_{OL}$	$I_F = 16 \text{ mA}, V_{CC} = 4.5 \text{ V}, I_O = 2.4 \text{ mA}$	—	—	0.4	V	

## Isolation Characteristics (Ta = 25°C)

Characteristic	Symbol	Test Conditions	Min	Typ.	Max	Unit
Capacitance input to output	$C_S$	$V = 0 \text{ V}, f = 1 \text{ MHz}$ (Note 6)	—	0.8	—	pF
Isolation resistance	$R_S$	R.H. $\leq 60\%$ , $V_S = 500 \text{ V}$ (Note 6)	$1 \times 10^{12}$	$10^{14}$	—	$\Omega$
Isolation voltage	$BV_S$	AC, 1 minute	3750	—	—	$V_{rms}$
		AC, 1 second, in oil	—	10000	—	
		DC, 1 minute, in oil	—	10000	—	Vdc

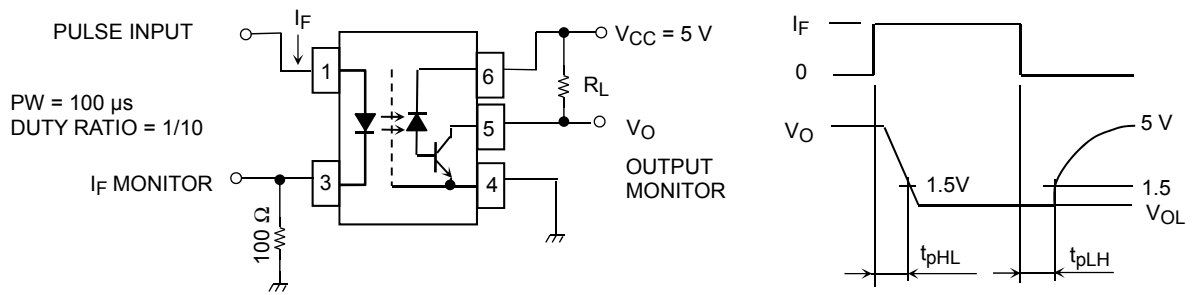
## Switching Characteristics (Ta = 25°C, VCC = 5 V)

Characteristic	Symbol	Test Circuit	Test Condition	Min	Typ.	Max	Unit
Propagation delay time (H→L)	$t_{pHL}$	1	$I_F = 0 \rightarrow 16 \text{ mA}$ $R_L = 1.9 \text{ k}\Omega$	—	—	0.8	$\mu\text{s}$
Propagation delay time (L→H)	$t_{pLH}$	1	$I_F = 16 \rightarrow 0 \text{ mA}$ $R_L = 1.9 \text{ k}\Omega$	—	—	0.8	$\mu\text{s}$
Common mode transient immunity at high output level (Note 7)	$CM_H$	2	$I_F = 0 \text{ mA}, V_{CM} = 400 \text{ V}_{p-p}$ $R_L = 4.1 \text{ k}\Omega$	5000	10000	—	V / $\mu\text{s}$
Common mode transient immunity at low output level (Note 7)	$CM_L$	2	$I_F = 16 \text{ mA}, V_{CM} = 400 \text{ V}_{p-p}$ $R_L = 4.1 \text{ k}\Omega$	-5000	-10000	—	V / $\mu\text{s}$

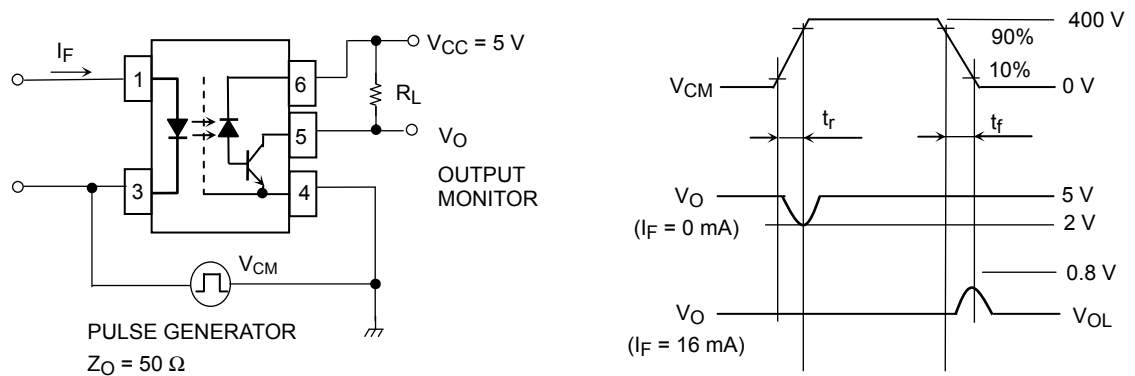
(Note) Maximum electrostatic discharge voltage for any pins: 100 V (C = 200 pF, R=0)

(Note 7)  $CM_L$  is the maximum rate of fall of the common mode voltage that can be sustained with the output voltage in the logic low state ( $V_O < 0.8 \text{ V}$ ).  
 $CM_H$  is the maximum rate of rise of the common mode voltage that can be sustained with the output voltage in the logic high state ( $V_O > 2.0 \text{ V}$ )

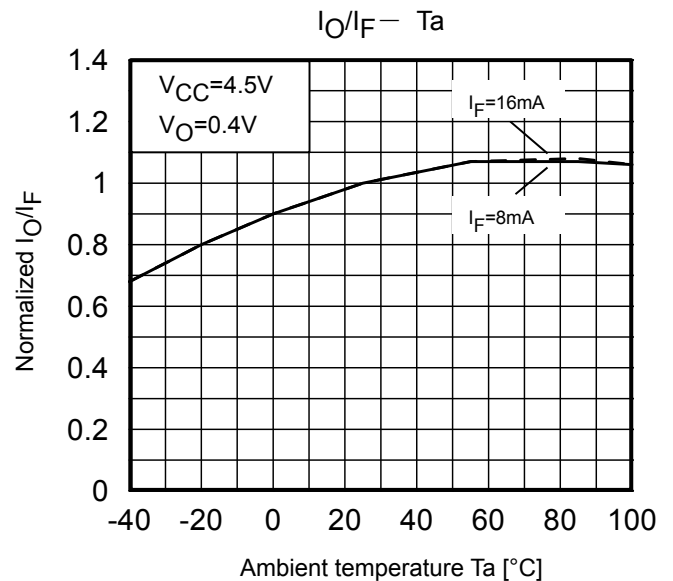
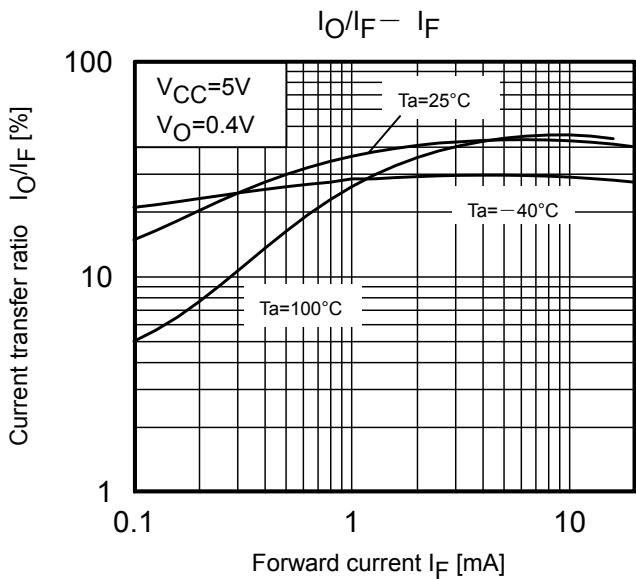
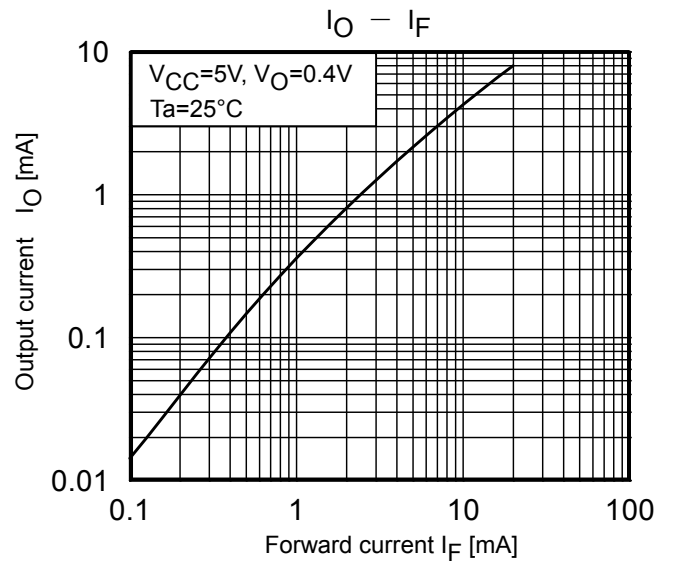
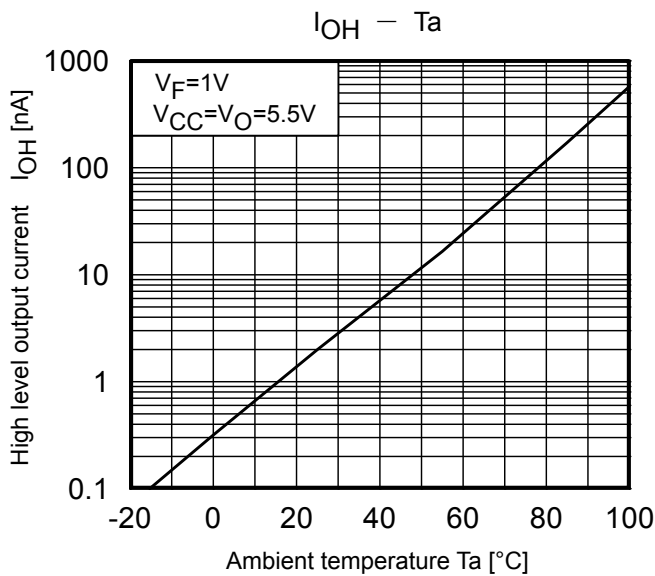
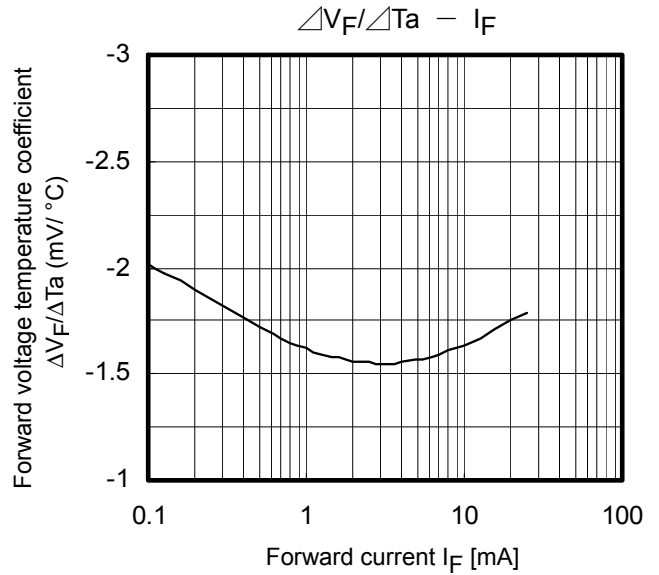
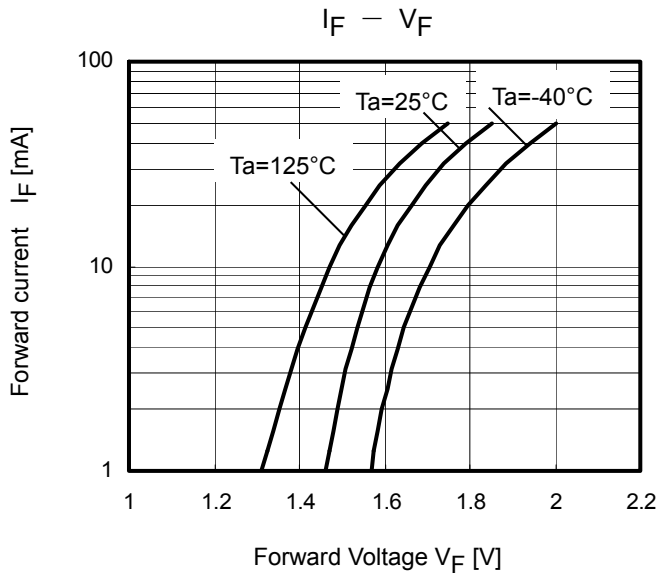
## Test Circuit 1: Switching Time Test Circuit



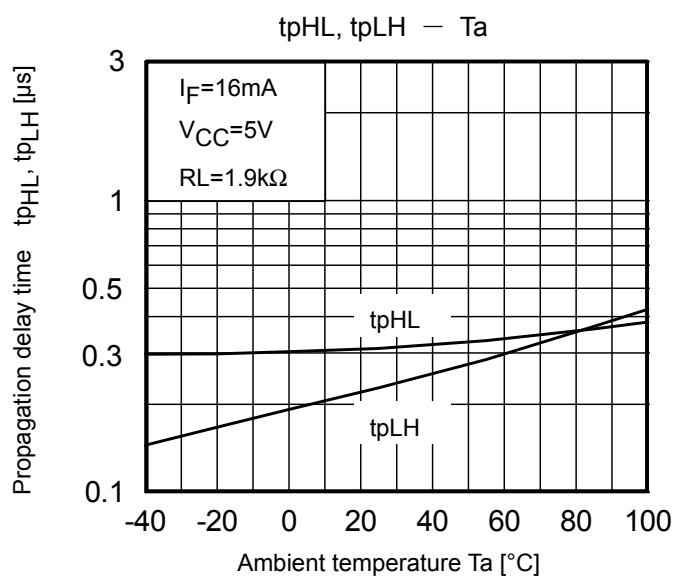
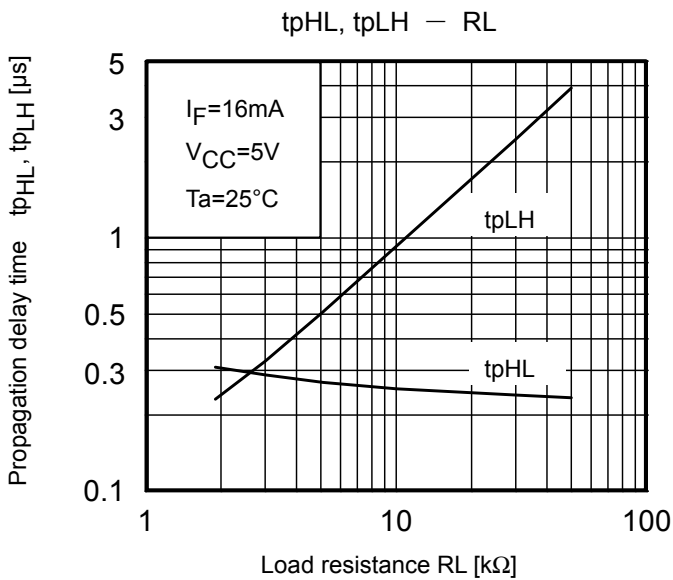
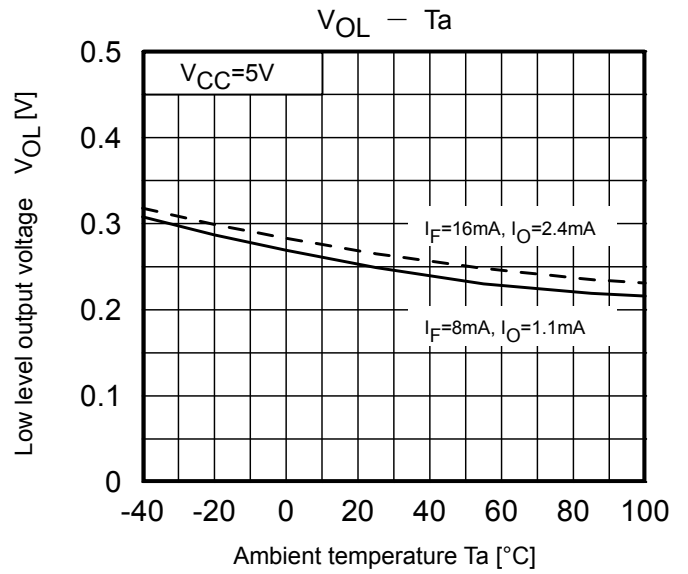
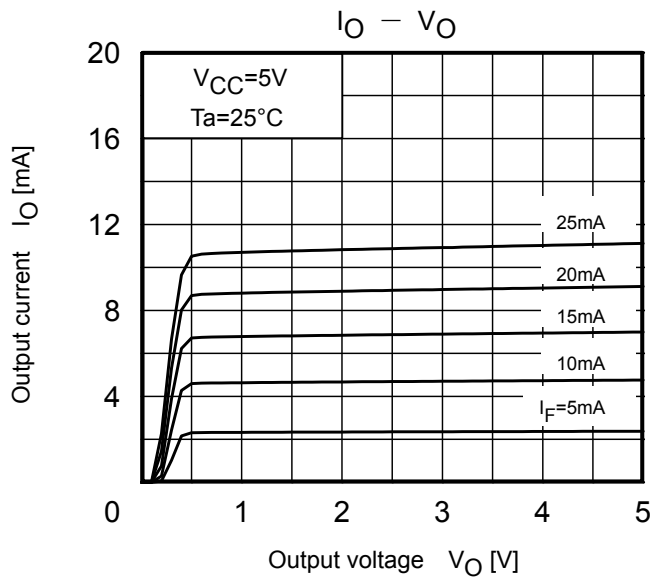
## Test Circuit 2: Common Mode Transient Immunity Test Circuit



$$CM_{Hi} = \frac{320(V)}{t_r(\mu s)}, \quad CM_{Li} = \frac{320(V)}{t_f(\mu s)}$$



\* The above graphs show typical characteristics.



\* The above graphs show typical characteristics.

**Specification for Embossed-Tape Packing (TPL)(TPR) for SO6 Coupler**

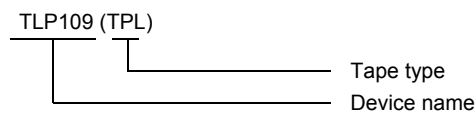
**1. Applicable Package**

Package	Product Type
SO6	Mini-flat coupler

**2. Product Naming System**

Type of package used for shipment is denoted by a symbol suffix after a product number. The method of classification is as below.

(Example)



**3. Tape Dimensions**

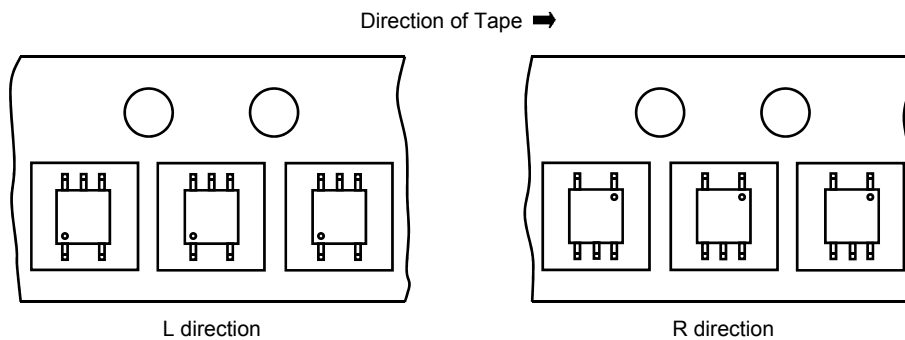
**3.1 Specification Classification Are as Shown in Table 1**

**Table 1 Tape Type Classification**

Tape type	Classification	Quantity (pcs / reel)
TPL	L direction	3000
TPR	R direction	3000

**3.2 Orientation of Device in Relation to Direction of Tape Movement**

Device orientation in the recesses is as shown in Figure 1.



**Figure 1 Device Orientation**

**3.3 Empty Device Recesses Are as Shown in Table 2.**

**Table 2 Empty Device Recesses**

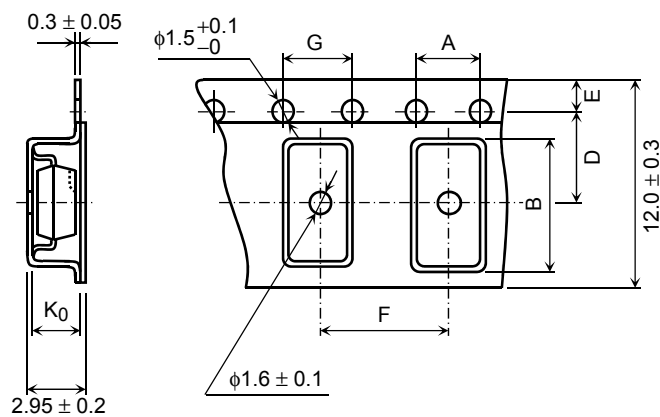
	Standard	Remarks
Occurrences of 2 or more successive empty device recesses	0	Within any given 40-mm section of tape, not including leader and trailer
Single empty device recesses	6 devices (max) per reel	Not including leader and trailer

**3.4 Start and End of Tape**

The start of the tape has 50 or more empty holes. The end of tape has 50 or more empty holes and two empty turns only for a cover tape.

**3.5 Tape Specification**

- (1) Tape material: Plastic (protection against electrostatics)
- (2) Dimensions: The tape dimensions are as shown in Figure 2 and Table 3.



**Figure 2 Tape Forms**

**Table 3 Tape Dimensions**

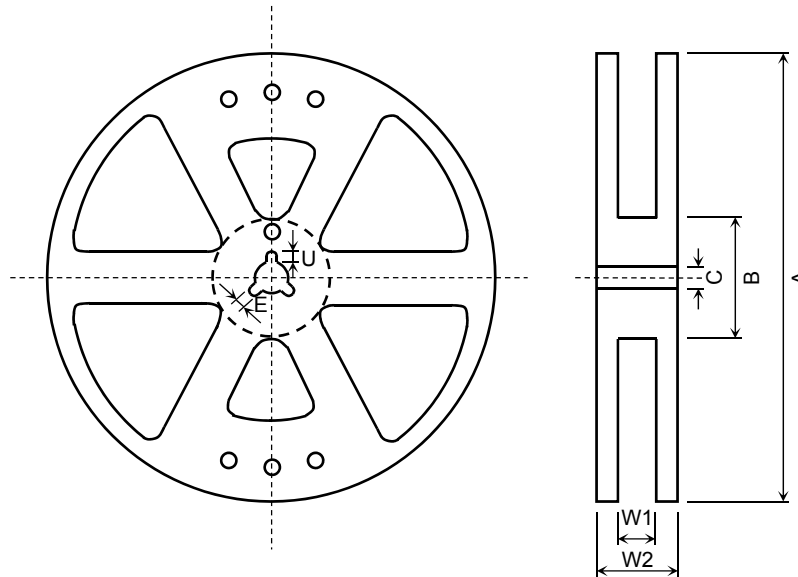
Unit: mm  
Unless otherwise specified: ±0.1

Symbol	Dimension	Remark
A	4.0	—
B	7.6	—
D	5.5	Center line of indented square hole and sprocket hole
E	1.75	Distance between tape edge and hole center
F	8.0	Cumulative error $\begin{matrix} +0.1 \\ -0.3 \end{matrix}$ (max) per 10 feed holes
G	4.0	Cumulative error $\begin{matrix} +0.1 \\ -0.3 \end{matrix}$ (max) per 10 feed holes
K <sub>0</sub>	2.6	Internal space



**3.6 Reel**

- (1) Material: Plastic
- (2) Dimensions: The reel dimensions are as shown in Figure 3 and Table 4.



**Figure 3 Reel Form**

**Table 4 Reel Dimensions**

Unit: mm

Symbol	Dimension
A	$\Phi 380 \pm 2$
B	$\Phi 80 \pm 1$
C	$\Phi 13 \pm 0.5$
E	$2.0 \pm 0.5$
U	$4.0 \pm 0.5$
W1	$13.5 \pm 0.5$
W2	$17.5 \pm 1.0$

**4. Packing**

Either one reel or five reels of photocoupler are packed in a shipping carton.

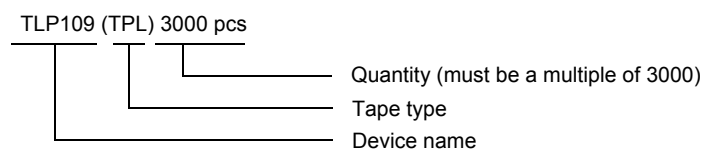
**5. Label Indication**

The carton bears a label indicating the product number, the symbol representing classification of standard, the quantity, the lot number and the Toshiba company name.

**6. Ordering Method**

When placing an order, please specify the product number, the tape type and the quantity as shown in the following example.

(Example)



## RESTRICTIONS ON PRODUCT USE

- Toshiba Corporation, and its subsidiaries and affiliates (collectively "TOSHIBA"), reserve the right to make changes to the information in this document, and related hardware, software and systems (collectively "Product") without notice.
- This document and any information herein may not be reproduced without prior written permission from TOSHIBA. Even with TOSHIBA's written permission, reproduction is permissible only if reproduction is without alteration/omission.
- Though TOSHIBA works continually to improve Product's quality and reliability, Product can malfunction or fail. Customers are responsible for complying with safety standards and for providing adequate designs and safeguards for their hardware, software and systems which minimize risk and avoid situations in which a malfunction or failure of Product could cause loss of human life, bodily injury or damage to property, including data loss or corruption. Before customers use the Product, create designs including the Product, or incorporate the Product into their own applications, customers must also refer to and comply with (a) the latest versions of all relevant TOSHIBA information, including without limitation, this document, the specifications, the data sheets and application notes for Product and the precautions and conditions set forth in the "TOSHIBA Semiconductor Reliability Handbook" and (b) the instructions for the application with which the Product will be used with or for. Customers are solely responsible for all aspects of their own product design or applications, including but not limited to (a) determining the appropriateness of the use of this Product in such design or applications; (b) evaluating and determining the applicability of any information contained in this document, or in charts, diagrams, programs, algorithms, sample application circuits, or any other referenced documents; and (c) validating all operating parameters for such designs and applications. **TOSHIBA ASSUMES NO LIABILITY FOR CUSTOMERS' PRODUCT DESIGN OR APPLICATIONS.**
- **PRODUCT IS NEITHER INTENDED NOR WARRANTED FOR USE IN EQUIPMENTS OR SYSTEMS THAT REQUIRE EXTRAORDINARILY HIGH LEVELS OF QUALITY AND/OR RELIABILITY, AND/OR A MALFUNCTION OR FAILURE OF WHICH MAY CAUSE LOSS OF HUMAN LIFE, BODILY INJURY, SERIOUS PROPERTY DAMAGE AND/OR SERIOUS PUBLIC IMPACT ("UNINTENDED USE").** Except for specific applications as expressly stated in this document, Unintended Use includes, without limitation, equipment used in nuclear facilities, equipment used in the aerospace industry, medical equipment, equipment used for automobiles, trains, ships and other transportation, traffic signaling equipment, equipment used to control combustions or explosions, safety devices, elevators and escalators, devices related to electric power, and equipment used in finance-related fields. **IF YOU USE PRODUCT FOR UNINTENDED USE, TOSHIBA ASSUMES NO LIABILITY FOR PRODUCT.** For details, please contact your TOSHIBA sales representative.
- Do not disassemble, analyze, reverse-engineer, alter, modify, translate or copy Product, whether in whole or in part.
- Product shall not be used for or incorporated into any products or systems whose manufacture, use, or sale is prohibited under any applicable laws or regulations.
- The information contained herein is presented only as guidance for Product use. No responsibility is assumed by TOSHIBA for any infringement of patents or any other intellectual property rights of third parties that may result from the use of Product. No license to any intellectual property right is granted by this document, whether express or implied, by estoppel or otherwise.
- **ABSENT A WRITTEN SIGNED AGREEMENT, EXCEPT AS PROVIDED IN THE RELEVANT TERMS AND CONDITIONS OF SALE FOR PRODUCT, AND TO THE MAXIMUM EXTENT ALLOWABLE BY LAW, TOSHIBA (1) ASSUMES NO LIABILITY WHATSOEVER, INCLUDING WITHOUT LIMITATION, INDIRECT, CONSEQUENTIAL, SPECIAL, OR INCIDENTAL DAMAGES OR LOSS, INCLUDING WITHOUT LIMITATION, LOSS OF PROFITS, LOSS OF OPPORTUNITIES, BUSINESS INTERRUPTION AND LOSS OF DATA, AND (2) DISCLAIMS ANY AND ALL EXPRESS OR IMPLIED WARRANTIES AND CONDITIONS RELATED TO SALE, USE OF PRODUCT, OR INFORMATION, INCLUDING WARRANTIES OR CONDITIONS OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE, ACCURACY OF INFORMATION, OR NONINFRINGEMENT.**
- GaAs (Gallium Arsenide) is used in Product. GaAs is harmful to humans if consumed or absorbed, whether in the form of dust or vapor. Handle with care and do not break, cut, crush, grind, dissolve chemically or otherwise expose GaAs in Product.
- Do not use or otherwise make available Product or related software or technology for any military purposes, including without limitation, for the design, development, use, stockpiling or manufacturing of nuclear, chemical, or biological weapons or missile technology products (mass destruction weapons). Product and related software and technology may be controlled under the applicable export laws and regulations including, without limitation, the Japanese Foreign Exchange and Foreign Trade Law and the U.S. Export Administration Regulations. Export and re-export of Product or related software or technology are strictly prohibited except in compliance with all applicable export laws and regulations.
- Please contact your TOSHIBA sales representative for details as to environmental matters such as the RoHS compatibility of Product. Please use Product in compliance with all applicable laws and regulations that regulate the inclusion or use of controlled substances, including without limitation, the EU RoHS Directive. **TOSHIBA ASSUMES NO LIABILITY FOR DAMAGES OR LOSSES OCCURRING AS A RESULT OF NONCOMPLIANCE WITH APPLICABLE LAWS AND REGULATIONS.**

## X-ON Electronics

Largest Supplier of Electrical and Electronic Components

*Click to view similar products for [High Speed Optocouplers](#) category:*

*Click to view products by [Toshiba](#) manufacturer:*

Other Similar products are found below :

[PS8502L2-AX](#) [ACNW261L-000E](#) [ACPL-344JT-000E](#) [ACPL-K49T-500E](#) [ACPL-K74T-000E](#) [ACPL-K75T-000E](#) [ACPL-W21L-560E](#) [ACPL-K44T-500E](#) [TLP187\(TPL,E\(T](#) [TLP2601\(TP1,F\)](#) [610737H](#) [6N137A-X001](#) [6N137A-X017T](#) [6N139-X007T](#) [HCPL2630M](#) [HCPL2731SM](#) [TLP555\(F\)](#) [HCPL2630SM](#) [PS2841-4A-F3-AX](#) [PS9817A-1-F3-AX](#) [PS9821-2-F3-AX](#) [ORPC-817D](#) [ORPC-817M/C](#) [ORPC-817M/B](#) [PT17-51C/L129\(BIN2\)](#) [TLP521-4GBSM](#) [UMW817C](#) [6N137S1\(TA\)](#) [TLP521GB](#) [TLP521GB-S](#) [PS2501](#) [PS2501-S](#) [TLP785GB](#) [TLP785GB-S](#) [LTV-214-G](#) [TLP2766A\(E](#) [TLP2766A\(LF4,E](#) [LCR-0202](#) [EL814S1\(TA\)-V](#) [PC817X4NSZ2B](#) [CYPC817](#) [OR-MOC3023](#) [TLP267J\(TPL,E\(T](#) [TLP109\(TPL,E\(O](#) [EL2514S1\(TU\)\(CLW\)-G](#) [EL816S2\(C\)\(TU\)-F](#) [TLP281-4](#) [MOC3023M](#) [ACPL-K49T-060E](#) [ACPL-K75T-500E](#)